

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KOSUKE SADAKATA	08/06/2018
TOSHIKAZU HARASHIMA	08/06/2018
HITOSHI NISHIMURA	08/06/2018
KENTARO YAMAMOTO	08/07/2018
MASAHIKO TAKANO	08/07/2018
RECEIVING PARTY DATA	
Name:	HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD.
Street Address:	3, KANDA NERIBEI-CHO
City:	CHIYODA-KU, TOKYO
State/Country:	JAPAN
Postal Code:	101-0022
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16084071
CORRESPONDENCE DATA	
Fax Number:	(202)628-8844
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-624-2500
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Address Line 1:	P.O. BOX 14300
Address Line 4:	WASHINGTON, D.C. 20044-4300
ATTORNEY DOCKET NUMBER:	109677.PB539US
NAME OF SUBMITTER:	OMAR A. GALIANO
SIGNATURE:	/Omar Alonso Galiano/
DATE SIGNED:	09/11/2018
Total Attachments: 2	
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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD., a corporation organized under the laws of Japan, located at 3, Kanda Neribeicho, Chiyoda-ku, Tokyo 101-0022 Japan receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

PACKAGE-TYPE COMPRESSOR

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Kosuke Sadakata</u> Kosuke SADAKATA	<u>August 6, 2018</u>
2) _____ Toshikazu HARASHIMA	_____
3) _____ Hitoshi NISHIMURA	_____
4) _____ Kentaro YAMAMOTO	_____
5) _____ Masahiko TAKANO	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

ASSIGNMENT
(譲渡証)

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI INDUSTRIAL EQUIPMENT SYSTEMS CO., LTD.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) _____ Kosuke SADAKATA	_____
2) <u>Toshikazu Harashina</u> Toshikazu HARASHIMA	<u>August 6, 2018</u>
3) <u>Hitoshi Nishimura</u> Hitoshi NISHIMURA	<u>August 6, 2018</u>
4) <u>Kentaro Yamamoto</u> Kentaro YAMAMOTO	<u>August 7, 2018</u>
5) <u>Masahiko Takano</u> Masahiko TAKANO	<u>August 7, 2018</u>
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

PATENT